

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/743,105
Applicant : Christoph Nolscher
Confirmation No. : 8012
Filed : December 23, 2003
TC/A.U. : 1756
Examiner : Chacko Davis, Deborah
Customer No. : 54500
Docket No. : 3000.0016C
Title : Method for Forming a Structure Element on a Wafer by
Means of a Mask and a Trimming Mask Assigned Hereto

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed January 17, 2007, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims, which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.